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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR μ PA1728

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The μ PA1728 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- · Single chip type
- · Low on-state resistance

RDS(on)1 = 19 m Ω TYP. (VGS = 10 V, ID = 4.5 A)

 $R_{DS(on)2} = 23 \text{ m}\Omega \text{ TYP. } (V_{GS} = 4.5 \text{ V}, I_{D} = 4.5 \text{ A})$

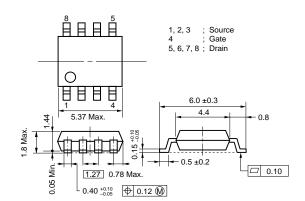
RDS(on)3 = 24 m Ω TYP. (Vgs = 4.0 V, ID = 4.5 A)

- Low Ciss: Ciss = 1700 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION PART NUMBER

DOOLUTE MAYIMUM	I RATINGS (TA = 25°C
μPA1728G	Power SOP8

PACKAGE DRAWING (Unit: mm)

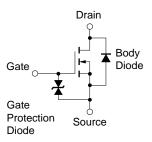


All terminals are connected.)

PACKAGE

Drain to Source Voltage (Vgs = 0 V)	V_{DSS}	60	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC)	I _{D(DC)}	±9	Α
Drain Current (Pulse) Note1	D(pulse)	±36	Α
Total Power Dissipation $(TA = 25^{\circ}C)^{Note2}$	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T_{stg}	-55 to + 150	°C
Single Avalanche Current Note3	las	9	Α
Single Avalanche Energy Note3	Eas	81	mJ

EQUIVALENT CIRCUIT



- **Notes 1.** PW \leq 10 μ s, Duty cycle \leq 1%
 - 2. Mounted on ceramic substrate of 1200 mm² x 2.2 mm
 - 3. Starting T_{ch} = 25°C, V_{DD} = 30 V, R_G = 25 Ω , T_{GS} = 20 \rightarrow 0 V

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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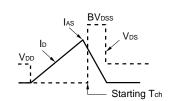


ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

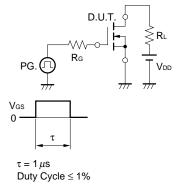
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V _{DS} = 60 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	y fs	V _{DS} = 10 V, I _D = 4.5 A	6.0	12		S
Drain to Source On-state Resistance	RDS(on)1	VGS = 10 V, ID = 4.5 A		19	26	mΩ
	RDS(on)2	Vgs = 4.5 V, ID = 4.5 A		23	29	mΩ
	RDS(on)3	VGS = 4.0 V, ID = 4.5 A		24	34	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1700		pF
Output Capacitance	Coss	V _{GS} = 0 V		270		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		130		pF
Turn-on Delay Time	td(on)	V _{DD} = 30 V, I _D = 4.5 A		17		ns
Rise Time	tr	V _{GS} = 10 V		69		ns
Turn-off Delay Time	td(off)	$R_G = 10 \Omega$		77		ns
Fall Time	t f			31		ns
Total Gate Charge	QG	V _{DD} = 48 V		31		nC
Gate to Source Charge	Qgs	V _{GS} = 10 V		4.4		nC
Gate to Drain Charge	Q _{GD}	ID = 9 A		9.1		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 9 A, Vgs = 0 V		0.82		٧
Reverse Recovery Time	trr	IF = 9 A, Vgs = 0 V		41		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		76		nC

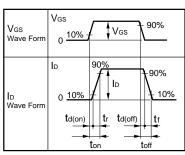
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{PG.} \\ \text{PG.} \\ \text{Vos} = 20 \rightarrow 0 \text{ V} \\ \text{M} \end{array} \begin{array}{c} \text{D.U.T.} \\ \text{N} \\ \text{N} \end{array} \begin{array}{c} \text{D.U.T.} \\ \text{N} \\ \text{N} \\ \text{N} \end{array}$

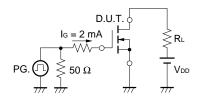


TEST CIRCUIT 2 SWITCHING TIME

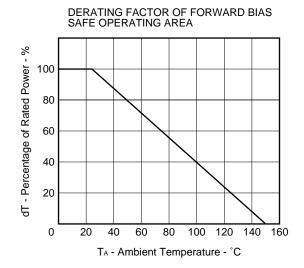


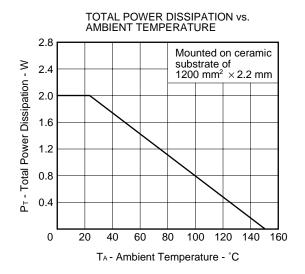


TEST CIRCUIT 3 GATE CHARGE

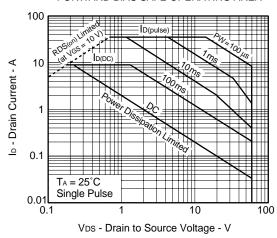


TYPICAL CHARACTERISTICS (T_A = 25°C)





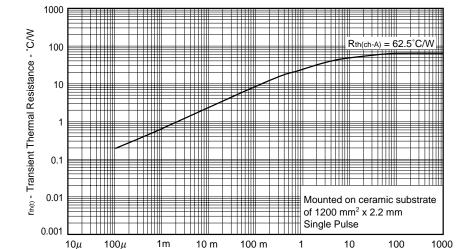
FORWARD BIAS SAFE OPERATING AREA



Remark

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

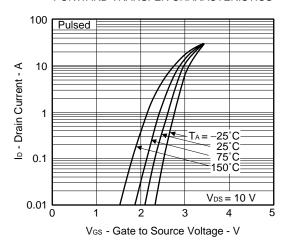
Mounted on ceramic substrate of 1200 mm² x 2.2 mm



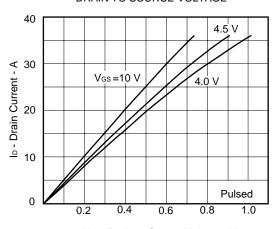
PW - Pulse Width - s

3

FORWARD TRANSFER CHARACTERISTICS

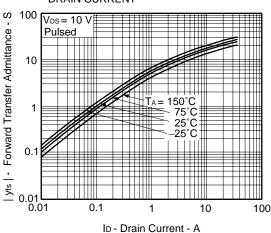


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

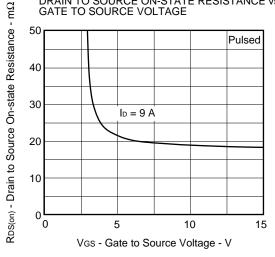


V_{DS} - Drain to Source Voltage - V

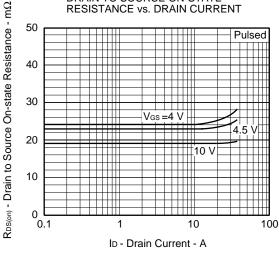
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

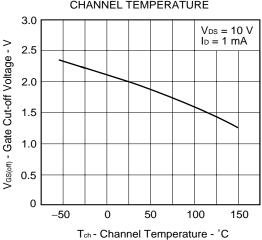


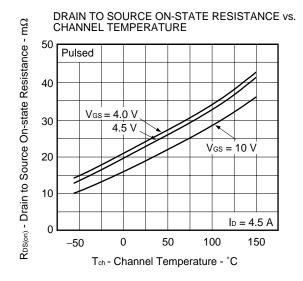
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

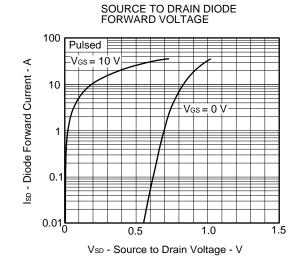


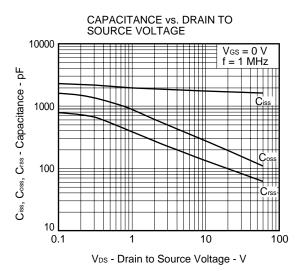
4

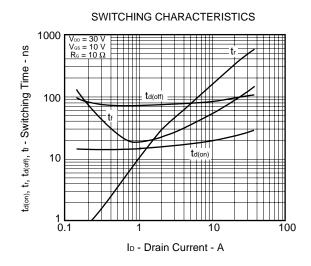
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

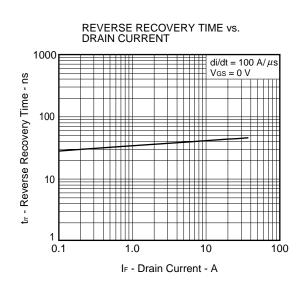


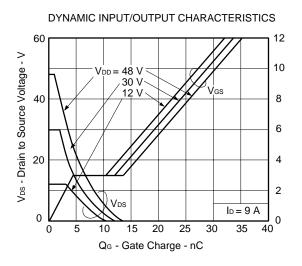


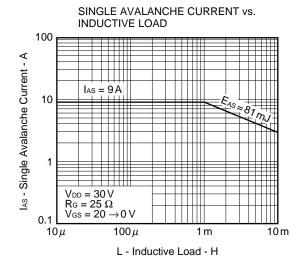


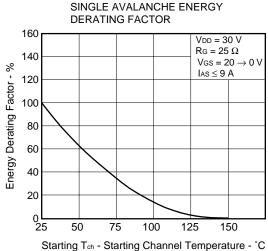












NEC μ PA1728

[MEMO]

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